

**YM-NT-750****Build Volume: 750\*750\*750 mm****Printing Temperature : Up to 275°C****Hot Bed Temperature: : Up to 120°C****Extrusion System : Dual Extruder For 1.75 Filament Or Single Extruder For 2.85/3.0mm Filament****Majority of the Materials on Market : ASA, ABS, CF-ABS, PETG, HIPS, PC, PA, TPU, PLA, CF-PLA, PVA...**

## Specification

Principle: Fused Filament Fabrication (FFF)

File Type: STL, OBJ, 3MF, GCODE

Filament Diameter: 1.75/2.85/3.0 mm

Data Transmission: SD Card, WIFI, USB

Layer Thickness: 0.1 – 0.6 mm

Machine Size: 1642×1110×1320 mm

Position Resolution: X/Y: 12.5 µm Z: 1.25 µm

Net Weight: 400KG

Supplied Software: IEMAI 3D EXPERT

Gross Weight: 450KG

Other Software: Cura, Simplify3D

Power: 200~250 V, 50~60 Hz 4500W

## Features

Power Failure Recovery

WIFI Control

Filament Absent Warning

Dual Or Single Extruder Modularization

Auto-Shut Down System

Vacuum Adsorption Platform

YM-NT-750 is specially designed for engineering plastic, with a temperature of 275°C extruder temperature and 120°C hot bed temperature, it is able to support most of the plastic on the market. It had a modular mechanism on the extruder which allow it to have simple maintenance and able to equip large-flow print extruder for massive print.